SiC Power Module

BSM300C12P3E301

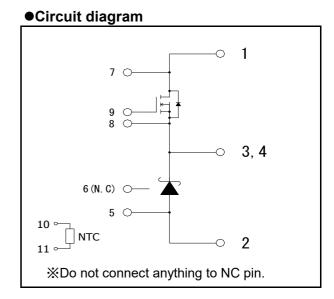
Datasheet

Application

· Converter

Features

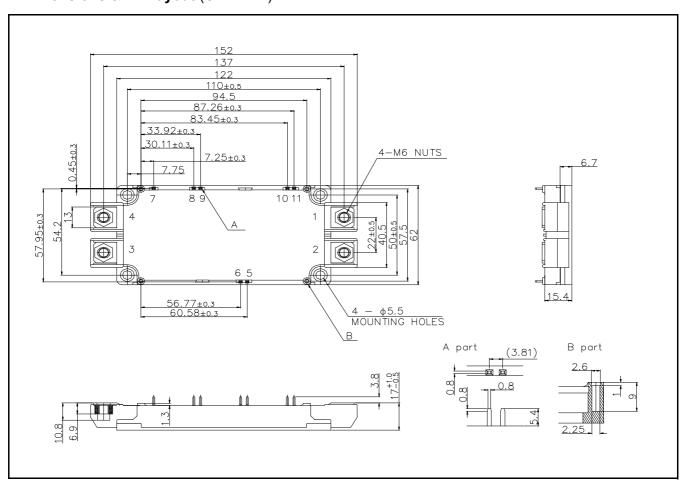
- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.



●Construction

This product is a chopper module consisting of SiC-UMOSFET and SiC-SBD from ROHM.

● Dimensions & Pin layout (Unit : mm)

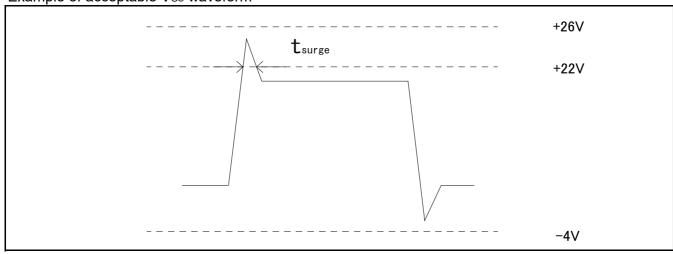


● Absolute maximum ratings (T_i = 25°C)

Parameter	Symbol	Conditions	Ratings	Unit	
Drain - Source Voltage	Source Voltage V _{DSS} G-S short		1200		
Repetitive Reverse Voltage	V_{RRM}	V _{RRM} Clamp diode			
Gate - Source Voltage (+)	V_{GSS}	D-S short	22	V	
Gate - Source Voltage (-) V _{GSS}		D-S short	-4		
G - S Voltage (t _{surge} <300nsec)	V _{GSSsurge}	D-S short	-4 to 26		
Drain Current Note 1)	I _D	DC(Tc=60°C) VGS=18V	288		
	I _D	DC (Tc = 50°C)	300		
	I _{DRM}	I _{DRM} Pulse (Tc = 60°C) 1ms VGS=18V _{Note 2)}			
Source Current Note 1)	I _S	DC(Tc=60°C) VGS=18V	288	1	
	I _S	DC(Tc=50°C) VGS=18V	300	А	
	I _{SRM}	Pulse (Tc = 60°C) 1ms VGS=18V Note 2)	600		
	I _{SRM}	I _{SRM} Pulse (Tc = 60°C) 10μs VGS=0V _{Note 2)}			
Forward Current	I _F	DC(Tc = 60°C)	300	1	
(clamp diode) Note 1)	I _{FRM}	Pulse (Tc = 60°C) 1ms Note 2)	600	1	
Total Power Dissipation Note 3)	Ptot	Tc = 25°C	1360	W	
Max Junction Temperature	Tjmax		175		
Junction Temperature	Tjop	Гјор		°C	
Storage Temperature	Tstg		-40 to 125	1	
Isolation Voltage	Visol	Terminals to baseplate f = 60Hz AC 1 min.	2500	Vrms	
Maunting Targus		Main Terminals : M6 screw	4.5	NI	
Mounting Torque	-	Mounting to heat sink M5 screw	3.5	N·m	

- Note 1) Case temperature (Tc) is defined on the surface of base plate just under the chips.
- Note 2) Repetition rate should be kept within the range where temperature rise if die should not exceed Tjmax.
- Note 3) Tj is less than 175°C.

Example of acceptable V_{GS} waveform



●Electrical characteristics (T_i=25°C)

Parameter	Symbol	Conditions		Ratings			Unit
- Farameter	Syllibol			Min.	Тур.	Max.	Offic
On-state static	Vos(on)	ID=300A,VGS=18V	Tj=25°C	_	1.9	3.0	V
Drain-Source Voltage			Tj=125°C	_	2.7	_	
		Tj=15		_	3.0	4.5	
Drain Cutoff Current	IDSS	Vps=1200V,Vgs=0V		_	_	10	μΑ
Forward Voltage	VF	I _F =300A	Tj=25°C	-	1.6	2.1	V
			Tj=125°C		2.2	-	
			Tj=150°C	_	2.3	3.2	
Reverse current	IRRM	Clamp diode		_	_	3.2	mA
Gate-Source Threshold Voltage	Vgs(th)	Vps=10V,lp=80mA		2.7	_	5.6	V
Gate-Source	Igss	Vgs=22V,Vps=0V		_	_	0.5	
Leak Current	IGSS	Vgs=-4V,Vps=0V	-0.5	_	_	μA	
Switching Characteristics	td(on)	Vgs(on)=18V、Vgs(off)=0V Vps=600V Ip=300A Rg(on)=2.7 ohm, Rg(off)=2.2 ohm Inductive load			40	_	ns
	tr				35	-	
	trr				20	-	
	td (off)				170	_	
	tf				30	_	
Input Capacitance	Ciss	VDS=10V,VGS=0V,200kHz			15	_	nF
Gate Registance	RGint	Tj=25°C			0.9	_	Ω
NTC Rated Resistance	R ₂₅				5	-	kΩ
NTC B Value	B50/25		_	3370	_	K	
Stray Inductance	Ls				13	-	nΗ
Creepage Distance	-	Terminal to heat sink			14.5		mm
		Terminal to terminal			15	-	mm
Clearance Distance	-	Terminal to heat sink			12	-	mm
		Terminal to terminal			9	-	mm
Junction-to -Case	Rth(j-c)	UMOSFET(1/2 module) Note 4) SBD(1/2 module) Note 4)			_	0.11	°C/W
Thermal Resistance	rtuig-c)				_	0.11	
Case-to -heat sink Thermal Resistance	Rth(c-f)	Case to heat sink, per 1 module. Thermal grease applied. $_{\text{Note 5})}$			0.035	_	

- Note 4) Measurement of Tc is to be done at the point just under the chip.
- Note 5) Typical value is measured by using thermally conductive grease of λ =0.9W/(m·K).
- Note 6) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- Note 7) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>

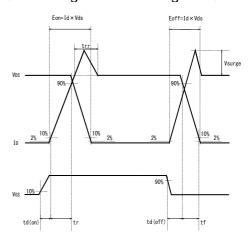


Fig.1 Output characteristic 25°C (TYP) 600 Vgs=16V 500 Vgs=18V Vgs=14V Drain current ID (A) Vgs=20V 400 300 Vgs=12V 200 100 Vgs=10V 0 2 6 8 0 Drain source voltage VDS (V)

Fig.2 Drain source voltage characteristic

Fig.3 Drain source voltage characteristic 25°C (TYP)

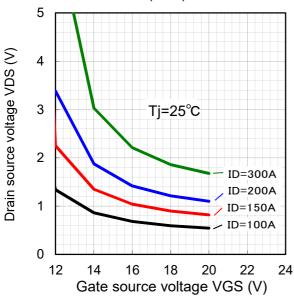


Fig.4 Ron vs Tj characteristic (TYP)

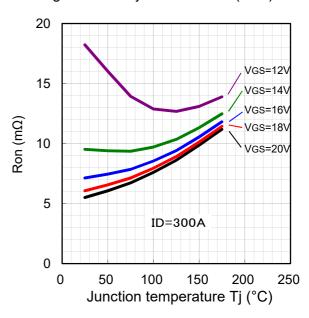


Fig.5 Forward characteristic of Diode (TYP)

1000

(V) SI TI = 150°C

Tj=125°C

Tj=25°C

Tj=25°C

Tj=25°C

Source drain voltage VF (V)

Fig.6 Forward characteristic of Diode (TYP) 600 500 Tj=25°C Source current IS (A) 400 300 Tj=150°C 200 Tj=125°C 100 0 0 2 5 Source drain voltage VF (V)

Fig.7 Drain Current vs Gate Voltage (TYP)

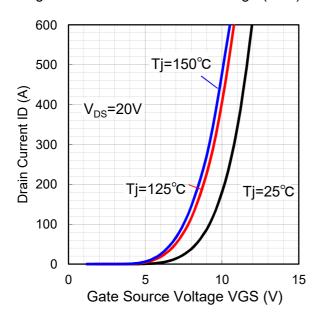
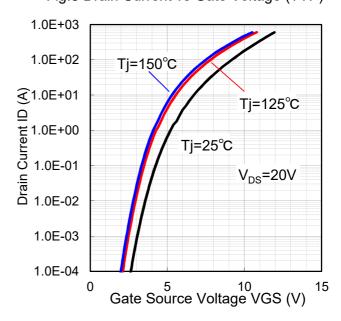


Fig.8 Drain Current vs Gate Voltage (TYP)



25°C (TYP)

1000

td(off)

td(on)

tr

 $Rg(on)=2.7\Omega$

 $Rg(off)=2.2\Omega$

INDUCTIVE LOAD

400

Drain current ID (A)

600

V_{DS}=600V

 $V_{GS}^{DS}(on)=18V$

200

 $V_{GS}(off)=0V$

1

0

Fig.9 Switching time vs drain current at

125°C (TYP) 1000 td(off) Switching time (ns) 100 td(on) 10 V_{DS}=600V $Rg(on)=2.7\Omega$ Rg(off)=2.2Ω INDUCTIVE LOAD $V_{GS}^{55}(on)=18V$ $V_{GS}(off)=0V$ 1 0 200 400 600 Drain current ID (A)

Fig.10 Switching time vs drain current at

Fig.11 Switching time vs drain current at 150°C (TYP)

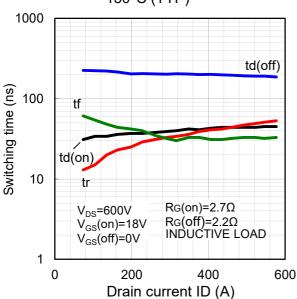


Fig.12 Switching loss vs drain current at 25°C (TYP)

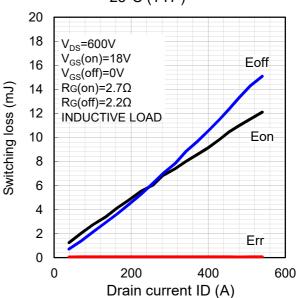


Fig.13 Switching loss vs drain current at 125°C (TYP)

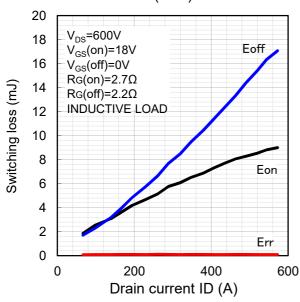


Fig.14 Switching loss vs drain current at 150°C (TYP)

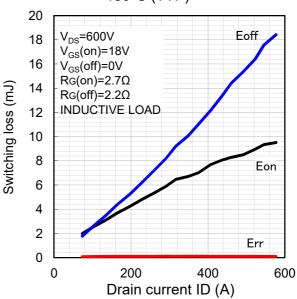


Fig.15 Recovery characteristic vs drain current at 25°C (TYP)

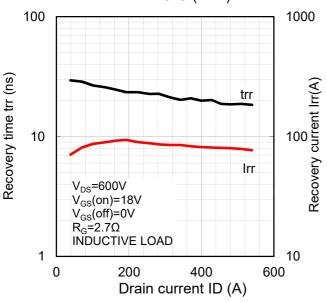


Fig.16 Recovery characteristic vs drain current at 125°C (TYP)

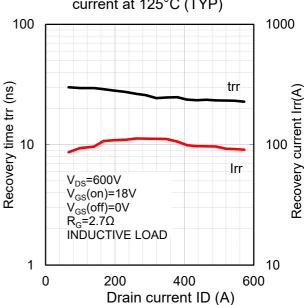


Fig.17 Recovery characteristic vs drain current at 150°C (TYP) 100 1000 trr Recovery time trr (ns) Recovery current Irr(A) 100 Irr V_{DS}=600V V_{GS}(on)=18V $V_{GS}(off)=0V$ $R_G = 2.7\Omega$ INDUCTIVE LOAD 1 10 0 200 400 600 Drain current ID (A)

at 25°C (TYP) 10000 V_{DS}=600V I_D=300A INDUCTIVE LOAD $V_{GS}(on)=18V$ $V_{GS}(off)=0V$ Switching time (ns) 000 000 td(off) tr td(on 10 10 100 1 Gate resistance RG (Ω)

Fig.18 Switching time vs gate resistance

Fig.19 Switching time vs gate resistance at 125°C (TYP) V_{DS}=600V INDUCTIVE LOAD I_D=300A $V_{GS}(on)=18V$ $V_{GS}(off)=0V$ td(off)

10000 Switching time (ns) 000 000 td(on) 10 1 10 100 Gate resistance RG (Ω)

Fig.20 Switching time vs gate resistance at 150°C (TYP)

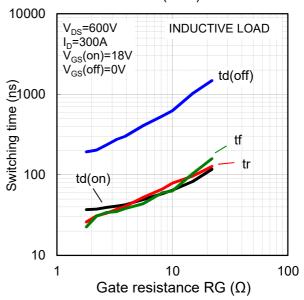


Fig.21 Switching loss vs gate resistance at 25°C (TYP)

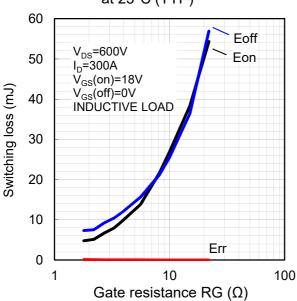


Fig.22 Switching loss vs gate resistance at 125°C (TYP)

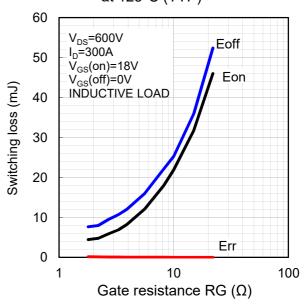


Fig.23 Switching loss vs gate resistance at 150°C (TYP)

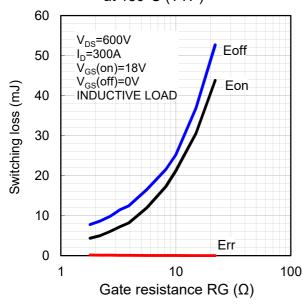
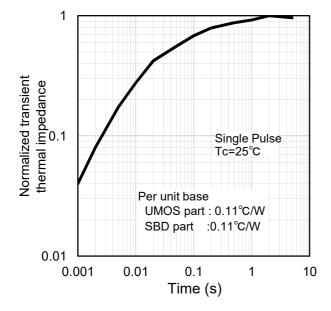


Fig.24 Capacitance vs Drain source voltage (TYP) 1.E-07 Ciss Capacitance(F) 80-3.1 60-3.1 Tj=25°C Coss Vgs=0V 200kHz Crss 1.E-10 0.01 0.1 10 100 1000 Drain source voltage VDS (V)

25 Gate source voltage VGS(V) 20 15 10 ID=300A V_{DS}=600V Tj=25°C 5 0 200 400 600 800 1000 0 Gate charge QG (nC)

Fig.25 Gate charge characteristic (TYP)

Fig.26 Transient thermal impedance (TYP)



Notes

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